Docket No.: JCLA46151

Form 1595 (Rev. 09/04) RECORDATION FORM (	COVER SHEET U.S. Department of Commerce Patent and Trademark Office					
PATENTS ONLY	<u> </u>					
To the Director of the U.S. Patent and Trademark Office: Please reco	rd the attached documents or the new address(es) below.					
Name of conveying party(ies):	2. Name/address of receiving Party(ies):					
Names(s)         Date of Execution           (1) Wen, Tsai-Yu         March 19, 2013           (2) Lu, Tsuo-Wen         March 19, 2013           (3) Wang, Yu-Ren         March 19, 2013           (4) Chien, Chin-Cheng         March 19, 2013           (5) Yu, Tien-Wei         March 19, 2013           (6) Hsu, Hsin-Kuo         March 19, 2013           (7) Lin, Yu-Shu         March 19, 2013           (8) Lai, Szu-Hao         March 19, 2013           (9) Chang, Ming-Hua         March 19, 2013	United Microelectronics Corp.  No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.					
3. Nature of conveyance: ☑ Assignment ☐ Merger ☐ Security Agreement ☐ Other ☐ Change of Name ☐ Reassignment  4. Application number(s) or patent number(s):	Add'l name(s)/address(es) of receiving parties Attached? □ Yes ☒ No					
A. Patent Application No. (s)	B. Patent No. (s)					
13/850,887						
Additional numbers attached?	☐ Yes 図 No					
<ol><li>Name and address of party to whom Correspondence concerning document should be mailed:</li></ol>	6. Total No. of applications and patents involved:  ONE (1)					
J. C. Patents 4, Venture Suite 250 Irvine, CA. 92618 Tel: (949) 660-0761 Fax: (949) 660-0809	7. Total fee (37 CFR §3.41): \$40.00  Authorized to be charge by credit card  Authorized to be charge to deposit account  Enclosed  None required (government interest not affecting title)  8. Payment Information  a. Credit Card Last Numbers  Expiration Date  b. Deposit Account Number 50-0710					
Atty Docket No.: JCLA46151	Authorized User Name <u>Jiawei Huang</u>					
9. Statement and Signature: To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.						
Jiawei Huang /JIAWEI HUANG/ Name of Person Signing Registration No. 43,330 Signature	March 26, 2013  Date  Total number of pages including cover sheet, attachments, and documents: 5					

PATENT REEL: 030114 FRAME: 0659

# DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

Declaration Submitted With Initial Filing							
OR							
Declaration Submitted After Initial Filing	(surcharge 37 CFR 1.16(f) required)						
(Title of the In	nvention)						
METHOD OF FORMING SEMICONDUCTOR DEVICE							
As a below named inventor (hereinafter de	esignated as the undersigned), I hereby						
declare that:							
This declaration is directed to:							
∑ The attached application,							
OR							
United States Application Number or PCT	International application number						
Filed on							
The above-identified application was made or	authorized to be made by me.						
believe I am the original inventor or an original the application.	ial joint inventor of a claimed invention in						
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#### DECLARATION AND ASSIGNMENT

#### FOR UTILITY OR DESIGN PATENT APPLICATION

WHEREAS, the undersigned has invented certain new and useful improvements described in the application identified.

WHEREAS 1. United Microelectronics Corp.

of No. 3, Li-Hsin Rd. II, Science-Based Industrial Park, Hsinchu, Taiwan, R.O.C.

hereinafter referred to as ASSIGNEE, is desirous of acquiring the undersigned's interest in the said invention and application and in any U.S. Letters Patent which may be granted on the same:

NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN: Be it known that, for good and valuable consideration, receipt of which is hereby acknowledged by the undersigned, the undersigned has/have sold, assigned and transferred, and by these presents does/do sell, assign and transfer unto the said Assignee, and Assignee's successors and assigns, all his/her/their rights, title and interest in and to the said invention and application and all future improvements thereon, and in and to any Letters Patent which may hereafter be granted on the same in the United States, the said rights, title and interest to be held and enjoyed by said Assignee as fully and exclusively as it would have been held and enjoyed by said the undersigned had this Assignment and transfer not been made, to the full end and term of any Letters Patent which may be granted thereon, or of any division, renewal, continuation in whole or in part, substitution, conversion, reissue, prolongation or extension thereof.

The undersigned further agrees/agree that he/she/they will, without charge to said Assignee, but at Assignee's expense, cooperate with Assignee in the prosecution of said application and/or applications, execute, verify, acknowledge and deliver all such further papers, including applications for Letters Patent and for the reissue thereof, and instruments of assignment and transfer thereof, and will perform such other acts as Assignee Lawfully may request, to obtain or maintain Letters Patent for said invention and improvement, and to vest title thereto in said Assignee, or Assignee's successors and assigns.

The undersigned hereby acknowledge that any willful false statement made in this declaration is punishable under 18 U.S.C. 1001 by fine or imprisonment of not more than five (5) years, or both.

## DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

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**RECORDED: 03/26/2013** 

### DECLARATION AND ASSIGNMENT FOR UTILITY OR DESIGN PATENT APPLICATION

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